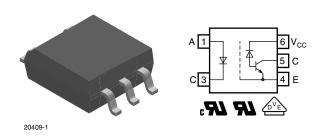


Analog High Speed Coupler, High Noise Immunity, 1 MBd, SOP-5 Package



DESCRIPTION

The VOM452 and VOM453, high speed optocouplers, each consists of a GaAlAs infrared emitting diode, optically coupled with an integrated photo detector and a high speed transistor. The photo detector is junction isolated from the transistor to reduce miller capacitance effects. The open collector output function allows circuit designers to adjust the load conditions when interfacing with different logic systems such as TTL, CMOS, etc.

Because the VOM452 and VOM453 have a Faraday shield on the detector chip, it can also reject and minimize high input to output common mode transient voltages. There is no base connection, further reducing the potential electrical noise entering the package.

The VOM452 and VOM453 are packaged in industry standard SOP-5 packages and are suitable for surface mounting.

This an ideal solution for Industrial communication bus isolation, as well as isolated drive circuit applications such as IPM (intelligent power module) drivers.

FEATURES

- Surface mountable
- · Industry standard SOP-5 footprint
- Compatible with infrared vapor phase reflow and wave soldering processes



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- Isolation test voltage, 3750 V_{RMS}
- Very high common mode transient immunity:
 15 000 V/µs at V_{CM} = 1500 V guaranteed (VOM453)
- High speed: 1 MBd
- TTL compatible
- · Open collector output
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Fieldbus communication and control
- Logic ground isolation
- · Analog signal ground isolation
- Replace pulse transformers
- IPM (intelligent power module) drivers

AGENCY APPROVALS

- UL1577
- cUL
- DIN EN 60747-5-5 (VDE 0884-5) available with option 1

ORDERING INFORMATION		
V 0 M	4 5 # PART NUMBER	7.21 mm
AGENCY CERTIFIED/PACKAGE	СМТІ	(kV/μs)
UL, cUL	≥1	≥ 15
SOP-5	VOM452T	VOM453T
UL, cUL, VDE	≥1	≥ 15
SOP-5	VOM452-X001T	VOM453-X001T

Notes

- For additional information on the available options refer to option information.
- · The product is available only on tape and reel.



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	NDITION SYMBOL VALUE						
INPUT								
Reverse voltage		V_R	3	V				
DC forward current		I _F	25	mA				
Surge forward current	$t_p \le 1 \mu s$, 300 pulses/s	I _{FSM}	1	А				
Power dissipation	T _{amb} ≤ 70 °C	P _{diss}	45	mW				
OUTPUT								
Supply voltage		V _S	-0.5 to +30	V				
Output voltage		V _O	-0.5 to +25	V				
Output current		I _O	8	mA				
Power dissipation	T _{amb} ≤ 70 °C	P _{diss}	100	mW				
COUPLER								
Storage temperature range		T _{stg}	-55 to +125	°C				
Ambient temperature range		T _{amb}	-55 to +100	°C				
Junction temperature		Tj	100	°C				
Soldering temperature	t < 10 s max.		260	°C				

Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS (T _{amb} = -40 °C to +100 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
INPUT								
Input forward voltage	I _F = 16 mA		V _F	-	1.4	1.8	V	
Input reverse current	V _R = 3 V		I _R	-	0.5	10	μΑ	
Input capacitance	$f = 1 \text{ MHz}, V_F = 0 \text{ V}, T_{amb} = 25 \text{ °C}$		C _{IN}	-	75	-	pF	
Temperature coefficient of forward voltage	I _F = 16 mA		$\Delta V_F/\Delta T_{amb}$	-	-1.7	-	mV/°C	
OUTPUT								
Logic low supply current	$I_F = 16 \text{ mA}, V_O = \text{open}, V_{CC} = 15 \text{ V}$		I _{CCL}	-	200	-	μΑ	
Logic high supply current	$I_F = 0$ mA, $V_O =$ open, $V_{CC} = 15$ V, $T_{amb} = 25$ °C		I _{CCH}	-	0.001	1	μΑ	
3 3 11 7	$I_F = 0$ mA, $V_O = open$, $V_{CC} = 15$ V		I _{CCH}		=.	2	μΑ	
Logic low output voltage	I_F = 16 mA, V_{CC} = 4.5 V, I_O = 3 mA, T_{amb} = 25 °C		V _{OL}	-	0.15	0.4	V	
	$I_F = 16 \text{ mA}, V_{CC} = 15 \text{ V}, I_O = 2.4 \text{ mA}$		V _{OL}	-	-	0.5	V	
	$I_F = 0 \text{ mA}, V_O = V_{CC} = 5.5 \text{ V}, T_{amb} = 25 \text{ °C}$		I _{OH}	-	0.003	0.5	μΑ	
Logic high output current	$I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V}, T_{amb} = 25 \text{ °C}$		I _{OH}	-	0.01	1	μΑ	
	$I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V}$		I _{OH}		=.	50	μΑ	
COUPLER								
Capacitance (input-output) (1)	f = 1 MHz, T _{amb} = 25 °C		C _{IO}		0.4	-	рF	

Notes

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements. All typical values are measured at T_{amb} = 25 °C.
 A 0.1 μF bypass capacitor connected between pins 4 and 6 is recommended.

CURRENT TRANSFER RATIO (T _{amb} = -40 °C to +100 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Current transfer ratio (1)(2)	$V_{O} = 0.5 \text{ V}, I_{F} = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}$	CTD	15	30	-	0/	
Current transfer ratio (1)(2)	$V_0 = 0.4 \text{ V. I}_E = 16 \text{ mA. } T_{amb} = 25 ^{\circ}\text{C}$	CTR	20	-	50	%	

Notes

(1) Current transfer ratio in percent equals the ratio of output collector current (I_O) to the forward LED input current (I_F) times 100.

(2) A 0.1 μF bypass capacitor connected between pins 4 and 6 is recommended. All typical values are measured at T_{amb} = 25 °C.



SWITCHING CHARACTERISTICS (T _{amb} = -40 °C to +100 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Propagation delay time to logic low at output (see fig. 1 and note 1)	V_{CC} = 5 V, I_F = 16 mA, R_L = 1.9 k Ω	t _{PHL}	-	0.2	1	μs	
Propagation delay time to logic high at output (see fig. 1 and note 1)	V_{CC} = 5 V, I_F = 16 mA, R_L = 1.9 k Ω	t _{PLH}	-	0.5	1	μs	

Note

(1) The 1.9 kΩ load represents 1 TTL unit load of 1.6 mA and the 5.6 kΩ pull-up resistor. All typical values are measured at T_{amb} = 25 °C.

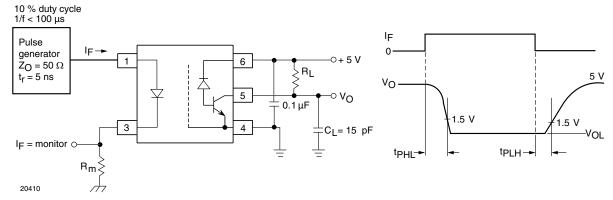


Fig. 1 - Test Circuit for Switching Times

COMMON MODE TRANSIENT IMMUNITY (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity at logic high level output (see fig. 2 and notes 1, and 2)	$R_L = 1.9 \text{ k}\Omega, I_F = 0 \text{ mA},$ $V_{CM} = 10 V_{P-P}$	VOM452T	CM _H	1000	-	-	V/µs
	$R_L = 1.9 \text{ k}\Omega, I_F = 0 \text{ mA}, V_{CM} = 1500 V_{P-P}$	VOM453T	CM _H	15 000	-	-	V/µs
at logic low level output	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, \ V_{CM} = 10 \text{ V}_{P-P}$	VOM452T	CM _L	1000	-	-	V/µs
	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, \ V_{CM} = 1500 \text{ V}_{P-P}$	VOM453T	CM _L	15 000	-	-	V/µs

Notes

- (1) Common mode transient immunity in a logic high level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse (V_{CM}) to assure that the output will remain in a logic high state (i.e., V_O > 2 V). Common mode transient immunity in a logic low level the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal (V_{CM} to assure that the output will remain in logic low state, i.e., V_O > 0.8 V).
- $^{(2)}$ The 1.9 k Ω load represents 1 TTL unit load of 1.6 mA and the 5.6 k Ω pull-up resistor.

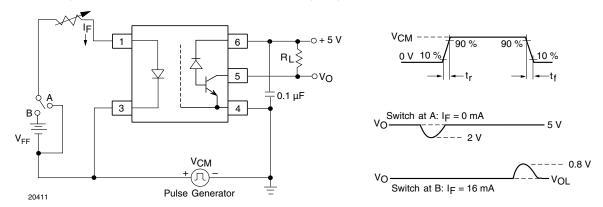


Fig. 2 - Test Circuit for Transient Immunity and Typical Waveforms



SAFETY AND INSULATION RATINGS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT				
Climatic classification	According to IEC 68 part 1		55 / 100 / 21					
Pollution degree	According to DIN VDE 0109		2					
Comparative tracking index	Insulation group IIIa	CTI	175					
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V _{ISO}	3750	V _{RMS}				
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V _{IOTM}	6000	V _{peak}				
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V _{IORM}	707	V _{peak}				
	T _{amb} = 25 °C, V _{IO} = 500 V	R _{IO}	≥ 10 ¹²	Ω				
Isolation resistance	T _{amb} = 100 °C, V _{IO} = 500 V	R _{IO}	≥ 10 ¹¹	Ω				
Output safety power		P _{SO}	350	mW				
Input safety current		I _{SI}	150	mA				
Input safety temperature		T _S	175	°C				
Creepage distance			≥ 5	mm				
Clearance distance			≥ 5	mm				
Insulation thickness		DTI	≥ 0.1	mm				
Input to output test voltage, method B	V _{IORM} x 1.875 = V _{PR} , 100 % production test with t _M = 1 s, partial discharge < 5 pC	V _{PR}	1669	V _{peak}				

Note

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

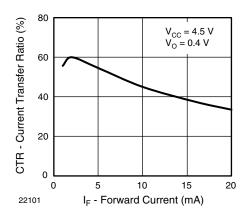


Fig. 3 - Current Transfer Ratio vs. Forward Current

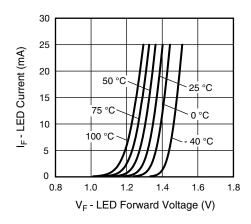


Fig. 4 - LED Current vs. LED Forward Voltage

[•] As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

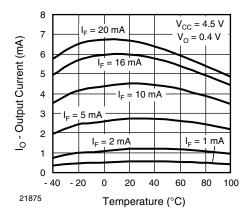


Fig. 5 - Output Current vs. Temperature

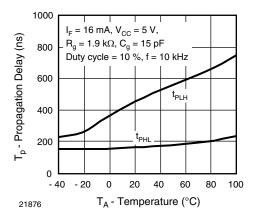


Fig. 6 - Propagation Delay vs. Temperature

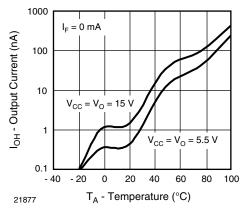


Fig. 7 - Logic High Output Current vs. Temperature

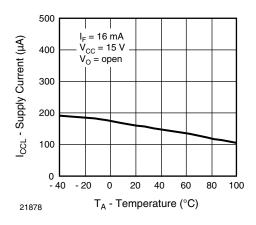


Fig. 8 - Supply Current vs. Temperature

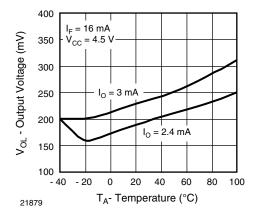
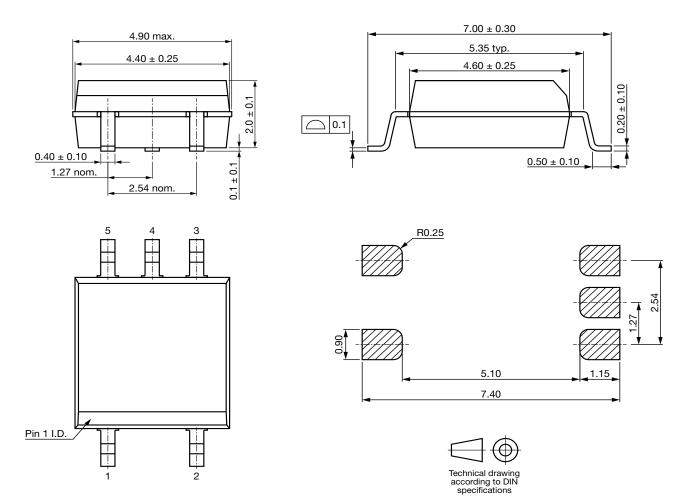


Fig. 9 - Logic Low Output Voltage vs. Temperature



PACKAGE DIMENSIONS (in millimeters)



PACKAGE MARKING

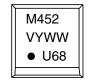


Fig. 10 - Example of VOM452T



Fig. 11 - Example of VOM452-X001T

Notes

- VDE logo is not part of the package marking.
- Tape and reel suffix (T) is not part of the package marking.

PACKING INFORMATION (tape and reel)

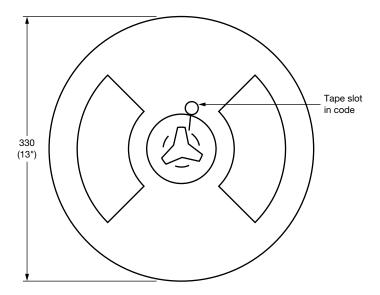


Fig. 12 - Tape and Reel Shipping Medium

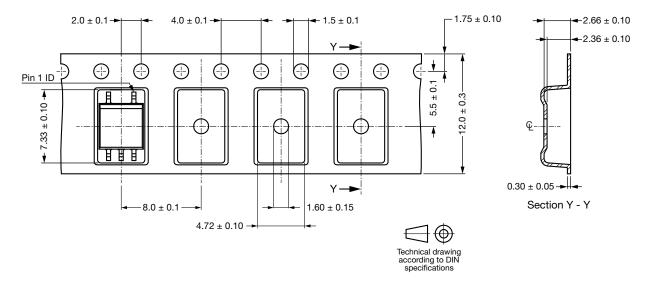


Fig. 13 - Tape and Reel Packing (2000 pieces on reel)



SOLDER PROFILE

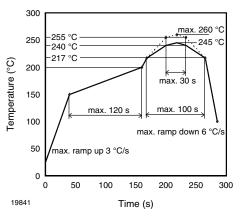


Fig. 14 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: T_{amb} < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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